



### **Product Summary**

| BV <sub>DSS</sub> | R <sub>DS(ON)</sub> Max        | I <sub>D</sub> Max<br>T <sub>A</sub> = +25°C |
|-------------------|--------------------------------|--|
| 20V               | 56mΩ @ V <sub>GS</sub> = 4.5V  | 2.8A   |
|                   | 65mΩ @ V <sub>GS</sub> = 2.5V  | 2.6A   |
|                   | 93mΩ @ V <sub>GS</sub> = 1.8V  | 2.2A   |
|                   | 140mΩ @ V <sub>GS</sub> = 1.5V | 1.8A   |

## **Description and Applications**

This MOSFET has been designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- General Purpose Interfacing Switch
- Power Management Functions
- **DC-DC** Converters
- Analog Switch

#### **20V N-CHANNEL ENHANCEMENT MODE MOSFET**

### **Features and Benefits**

- Low On-Resistance .
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- An Automotive-Compliant Part is Available Under Separate Datasheet (DMN2065UWQ)

## **Mechanical Data**

- Case: SOT323
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Alloy42 Leadframe. Solderable per MIL-STD-202, Method 208 3
- Weight: 0.027 grams (Approximate)

Dra **SOT323** Ga G Source Top View Equivalent Circuit Top View

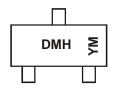
### Ordering Information (Note 4)

|        | Part Number                               | Case  | Packaging                   |
|--------|---|---|-----------------------------|
|        | DMN2065UW-7                               | SOT323  | 3000/Tape & Reel            |
| Notes: | 1. No purposely added lead. Fully EU Dire | ctive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015 | /863/EU (RoHS 3) compliant. |

lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant

- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and 1000ppm antimony compounds.
- For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## Marking Information



DMH = Product Type Marking Code YM = Date Code Marking Y = Year (ex: F = 2018)

M = Month (ex: 9 = September)

#### Date Code Key

| Date Code Rey |     |     |      |     |      |     |     |      |     |      |     |      |
|---------------|-----|-----|------|-----|------|-----|-----|------|-----|------|-----|------|
| Year          | 201 | 8   | 2019 |     | 2020 | 20  | )21 | 2022 |     | 2023 |     | 2024 |
| Code          | F   |     | G    |     | Н    |     |     | J    |     | K    |     | L    |
| Month         | Jan | Feb | Mar  | Apr | Мау  | Jun | Jul | Aug  | Sep | Oct  | Nov | Dec  |
| Code          | 1   | 2   | 3    | 4   | 5    | 6   | 7   | 8    | 9   | 0    | N   | D    |



# **Maximum Ratings** ( $@T_A = +25^{\circ}C$ , unless otherwise specified.)

| Characteristic                                    | Symbol                                    | Value                                     | Unit             |            |   |
|---|---|---|------------------|------------|---|
| Drain-Source Voltage                              | V <sub>DSS</sub>                          | 20  | V                |            |   |
| Gate-Source Voltage                               |   |   | V <sub>GSS</sub> | ±12        | V |
|   | Steady<br>State                           | $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$ | ID               | 2.8<br>2.3 | А |
| Continuous Drain Current (Note 6) $V_{GS} = 4.5V$ | t<10s                                     | $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$ | ID               | 3.1<br>2.6 | А |
|   | $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$ | ID  | 2.2<br>1.7       | А          |   |
| Continuous Drain Current (Note 6) $V_{GS} = 1.8V$ | t<10s                                     | $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$ | ID               | 2.4<br>1.9 | А |
| Pulsed Drain Current (10us Pulse, Duty Cycle=1%)  | IDM                                       | 30  | А                |            |   |
| Maximum Body Diode Forward Current (Note 5)       | ls  | 1.2                                       | А                |            |   |

### Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                                   |              | Symbol                           | Value       | Unit |
|--|--------------|----------------------------------|-------------|------|
| Total Power Dissipation (Note 5)                 |              | PD                               | 0.43        | W    |
| Thermal Resistance, Junction to Ambient (Note 5) | Steady State | Р                                | 296         | °C/W |
| merinal Resistance, Junction to Ambient (Note 5) | t<10s        | R <sub>0JA</sub>                 | 252         | °C/W |
| Total Power Dissipation (Note 6)                 |              | Po                               | 0.7         | W    |
| Thermal Resistance, Junction to Ambient (Note 6) | Steady State |                                  | 178         | °C/W |
| mermai Resistance, Junction to Ambient (Note 6)  | t<10s        | R <sub>θ</sub> JA                | 151         | °C/W |
| Operating and Storage Temperature Range          |              | T <sub>J,</sub> T <sub>STG</sub> | -55 to +150 | °C   |

## **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                              | Symaphia             | Mim  | Turn  | Max | Unit | Test Condition   |
|---|----------------------|------|-------|-----|------|--|
| OFF CHARACTERISTICS (Note 7)                | Symbol               | Min  | Тур   | wax | Unit | Test Condition   |
| `,  | D\/                  | 20   |       |     | V    | $\lambda = 0 \lambda = 1 m \Lambda$                        |
| Drain-Source Breakdown Voltage              | BV <sub>DSS</sub>    | 20   | -     | -   |      | $V_{GS} = 0V, I_D = 1mA$                                   |
| Zero Gate Voltage Drain Current @Tc = +25°C |                      | -    | -     | 1   | μA   | $V_{DS} = 20V, V_{GS} = 0V$                                |
| Gate-Source Leakage                         | IGSS                 | -    | -     | ±1  | μA   | $V_{GS} = \pm 10V, V_{DS} = 0V$                            |
| ON CHARACTERISTICS (Note 7)                 |                      |      |       |     |      | I  |
| Gate Threshold Voltage                      | V <sub>GS(TH)</sub>  | 0.35 | -     | 1.0 | V    | $V_{DS} = V_{GS}, I_D = 250 \mu A$                         |
|   |                      | -    | 52    | 56  |      | $V_{GS} = 4.5V, I_D = 2A$                                  |
| Static Drain-Source On-Resistance           | D                    | -    | 59    | 65  | mΩ   | $V_{GS} = 2.5V, I_D = 2A$                                  |
| Static Drain-Source On-Resistance           | R <sub>DS</sub> (ON) | -    | 60    | 93  | mΩ   | $V_{GS} = 1.8V, I_D = 1A$                                  |
|   |                      | -    | 75    | 140 |      | $V_{GS} = 1.5V, I_D = 0.5A$                                |
| Forward Transfer Admittance                 | Y <sub>fs</sub>      | -    | 7     | -   | S    | $V_{DS} = 5V, I_D = 3.8A$                                  |
| Diode Forward Voltage                       | V <sub>SD</sub>      | -    | 0.7   | 1.0 | V    | $V_{GS} = 0V, I_{S} = 1A$                                  |
| DYNAMIC CHARACTERISTICS (Note 8)            |                      |      |       |     |      |  |
| Input Capacitance                           | Ciss                 | -    | 400.0 | -   | рF   |  |
| Output Capacitance                          | Coss                 | -    | 73.8  | -   | pF   | V <sub>DS</sub> = 10V, V <sub>GS</sub> = 0V,<br>f = 1.0MHz |
| Reverse Transfer Capacitance                | C <sub>rss</sub>     | -    | 65.6  | -   | рF   | 1 - 1.00012  |
| Total Gate Charge                           | Qg                   | -    | 5.4   | -   | nC   | $V_{GS} = 4.5V, V_{DS} = 10V,$                             |
| Gate-Source Charge                          | Qgs                  | -    | 0.7   | -   | nC   | $I_D = 6A$   |
| Gate-Drain Charge                           | Q <sub>gd</sub>      | -    | 1.4   | -   | nC   |  |
| Turn-On Delay Time                          | t <sub>D(ON)</sub>   | -    | 3.5   | -   | ns   |  |
| Turn-On Rise Time                           | t <sub>R</sub>       | -    | 9.7   | -   | ns   | $V_{DD} = 10V, V_{GS} = 5V,$                               |
| Turn-Off Delay Time                         | tD(OFF)              | -    | 23.8  | -   | ns   | $R_L = 1.7\Omega, R_G = 6\Omega$                           |
| Turn-Off Fall Time                          | tF                   | -    | 7.2   |     | ns   |  |

Notes: 5. Device mounted on FR-4 substrate PC board, with minimum recommended pad layout.

6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

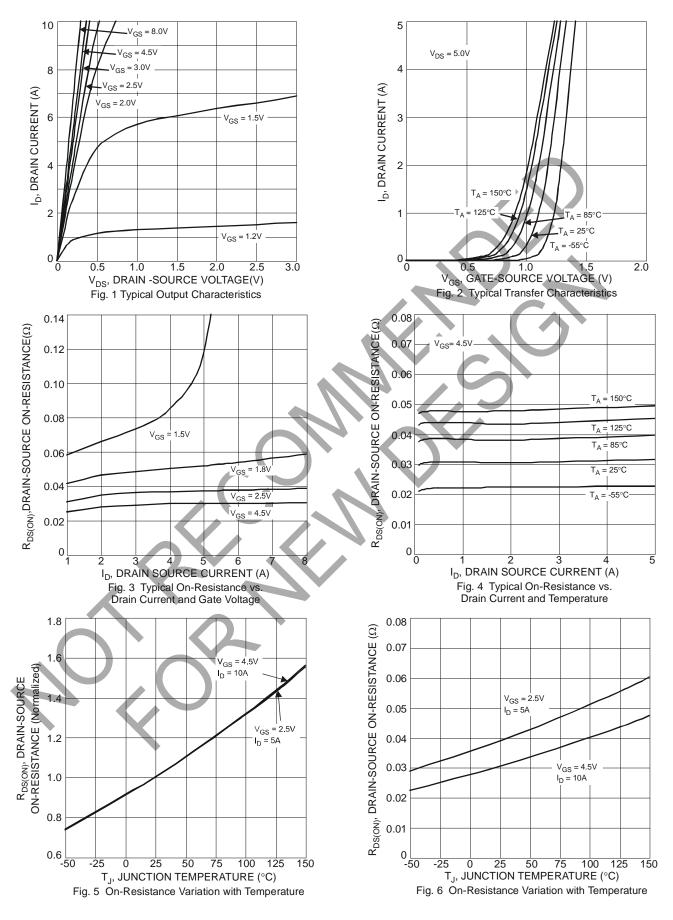
7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing.



#### NOT RECOMMENDED FOR NEW DESIGN USE <u>DMN2058UW</u>

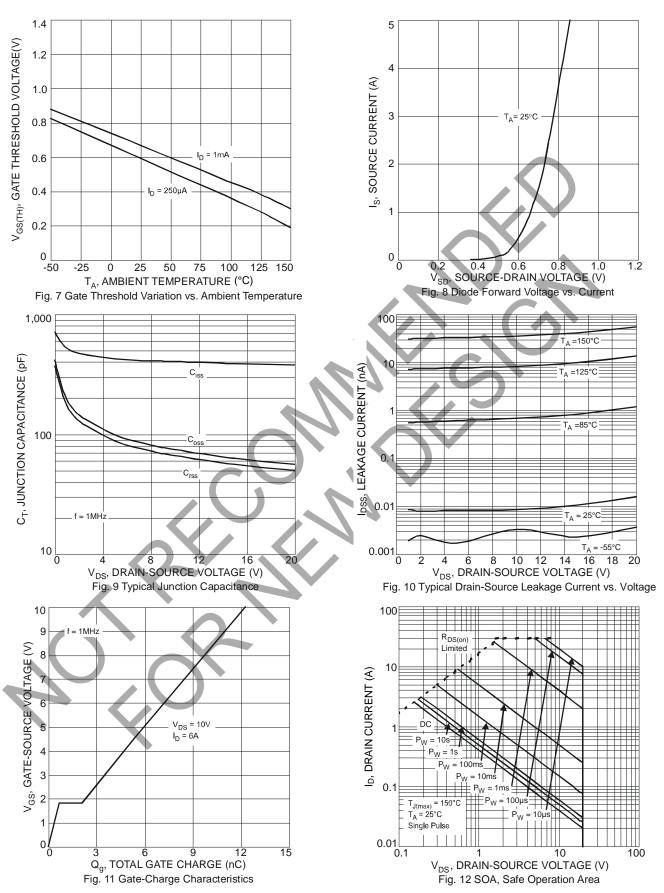
### **DMN2065UW**





#### NOT RECOMMENDED FOR NEW DESIGN USE <u>DMN2058UW</u>

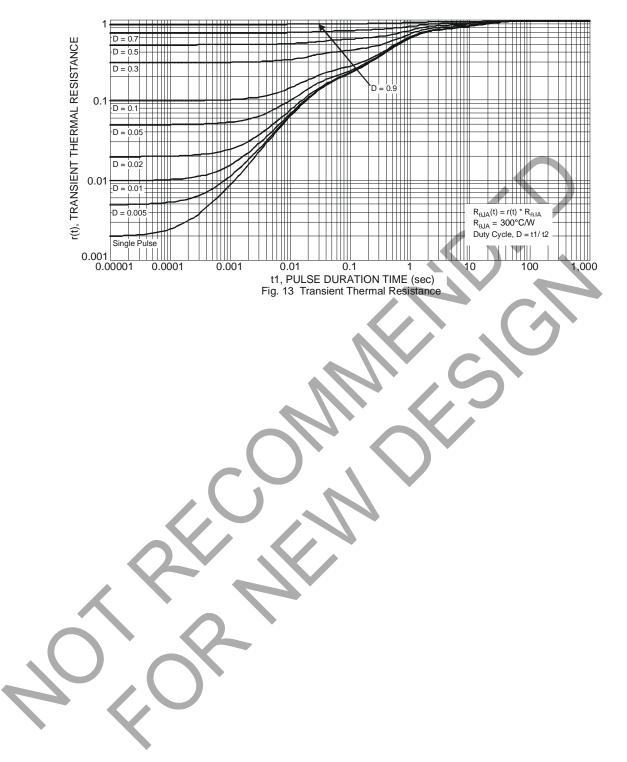
### **DMN2065UW**





### NOT RECOMMENDED FOR NEW DESIGN USE <u>DMN2058UW</u>

## **DMN2065UW**

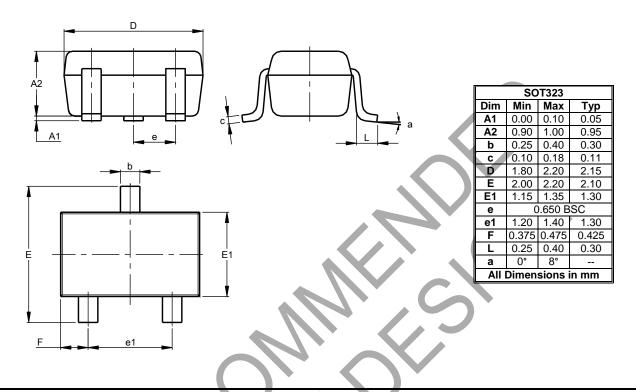




### **Package Outline Dimensions**

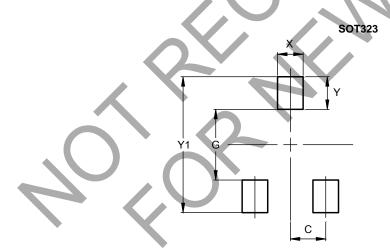
Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT323



### Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



| Dimensions | Value<br>(in mm) |
|------------|------------------|
| С          | 0.650            |
| G          | 1.300            |
| Х          | 0.470            |
| Y          | 0.600            |
| Y1         | 2.500            |



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